

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JAE SEOK YI	03/11/2020
IL RO LEE	03/11/2020
CHANG HAK CHOI	03/13/2020
BON SEOK KOO	03/11/2020
JUNG MIN KIM	03/11/2020
BYUNG WOO KANG	03/11/2020
SAN KYEONG	03/11/2020
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City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17971914
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ATTORNEY DOCKET NUMBER:	123193-8887-US
NAME OF SUBMITTER:	CHRISTINE PEOPLES
SIGNATURE:	/Christine Peoples/
DATE SIGNED:	10/24/2022

Total Attachments: 3

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other relevant treaties;

I hereby authorize and request the United States Patent and Trademark Office and officials in patent offices in foreign countries to issue any and all of said Letters Patent to the ASSIGNEE as the assignee of my entire right, title, and interest in and to the same, for the sole use and benefit of the ASSIGNEE, and its lawful successors and assigns, to the full end of the term for which said Letters Patent may be granted;

I hereby grant the attorney of record the power to insert on this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office or other authority for recordation of this document;

I hereby covenant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment; and

Further, I hereby further covenant and agree that I will, without further consideration, communicate with the ASSIGNEE, and its lawful successors and assigns, any facts known to me respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said ASSIGNEE, and its lawful successors or assigns, execute all divisional, continuation, continuation-in-part, and reissue applications, make all rightful oaths and generally do everything possible to aid the ASSIGNEE, and its lawful successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the ASSIGNEE, and its lawful successors and assigns.

IN TESTIMONY WHEREOF, I have hereunto set my hands.

NAME OF INVENTOR (Full Legal Name): Jaeseok YI

Signature: _____

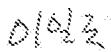


Date: _____

03/11/2020

NAME OF INVENTOR (Full Legal Name): Il Ro LEE

Signature: _____

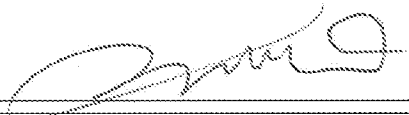


Date: _____

03/11/2020

NAME OF INVENTOR (Full Legal Name): Chang Hak CHOI

Signature: _____

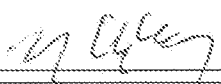


Date: _____

03/13/2020

NAME OF INVENTOR (Full Legal Name): Bon Seok KOO

Signature: _____



Date: _____

03/11/2020

Morgan, Lewis & Bockius LLP

NAME OF INVENTOR (Full Legal Name) : <u>Jung Min KIM</u>	
Signature: <u>Jung Min Kim</u>	Date: <u>03/11/2020</u>
NAME OF INVENTOR (Full Legal Name) : <u>Byung Woo KANG</u>	
Signature: <u>강병우</u>	Date: <u>03/11/2020</u>
NAME OF INVENTOR (Full Legal Name) : <u>San KYEONG</u>	
Signature: <u>경상</u>	Date: <u>03/11/2020</u>

[Faint handwritten signature]

Morgan, Lewis & Bockius LLP